COUNT	DESCRIPTION	DESCRIPTION OF REVISI		ONS BY C		HKD DATE		COUNT	DESCRIPTION OF	REVISIONS	BY	CHKD	DAT	ΓΕ
							\triangle							
APPLICA	APPLICABLE STANDARD													
RATING	e RANGE -35 °C TO +85 °C(NOT					ΓΕ1)				1)O°0(NOTI	E2)		
VOLTAG		E	250			\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			ICABLE DF1E-		E- *	- * S-2. 5C		
	T 3 A													
						PECIFIC	CAT	101					, , , ,	
	ГЕМ	TEST METHOD							REQUIREMENTS				QT	AT
	RUCTION												r	
GENERAL E								ACCORDING TO DRAWING.				×	×	
MARKING		CONFIRMED VISUALLY.										×	×	
		TERISTICS										, ,		
MILLIVOLT LEVEL		20 mV MAX, 1 mA(DC OR 1000 Hz).							30 mΩ MAX.				×	_ '
METHOD. INSULATION		500 V DC.											+	
RESISTANO	· .											×		
VOLTAGE F	650 V AC FOR 1 min.							NO FLASHOVER	NO FLASHOVER OR BREAKDOWN.					
MECHA	NICAL CHAI													
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.							① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				×	_
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.							① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② CONTACT RESISTANCE: 30 mΩ MAX.				×	_	
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.							③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				×	_
ENVIRO	NMENTAL (CHAR/	CTE	RIST	TICS									
RAPID CHANGE OF		TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35 °C							① CONTACT RESISTANCE: 30 mΩ MAX.				×	-
TEMPERATURE		TIME 30→ 5 MAX→ 30→ 5 MAX min UNDER 5 CYCLES.							 INSULATION RESISTANCE: 1000 MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				1	
DAMP HEAT		EXPOS	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.							① CONTACT RESISTANCE: 30 mΩ MAX.				
(STEADY STATE)									 INSULATION RESISTANCE: 500 MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 					
RESISTANO	1) AUTOMATIC SOLDERING (FLOW)							NO DEFORMATION OF CASE OF				×	_	
SOLDERING HEAT		SOLDER TEMPERATURE, 260 ℃ FOR IMMERSION, DURATION, 10 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE: 300 ℃, SOLDERING TIME: 3 sec. NO STRENGTH ON CONTACT.							EXCESSIVE LOOSENESS OF THE TERMINALS.					
i [.]														
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 235 °C FOR INSERTION DURATION, 5 s.							SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.					-
					<u> </u>		3201111							
REMARKS							DRAWN		DESIGNED	CHECKED	APP	ROVED	RELE	ASED
NOTE1: INCL	URE RISING BY CURRENT.					520.025	· · · · · · · · · · · · · · · · · · ·							
		TION OF LONG TERM STORAGE ITS BEFORE PCB ON BOARD,												
AFTE HUMI	ERATING TEMPERATURE AND PPLIED FOR INTERIM STORAGE					F.F	Matsu	ki 7. Umehora J. Cha J. Ona 2 04.04.13 04.04.15 04.04.15						
DURII Unless ot	fied, refer to JIS C 5402.) ⁰	04.04.12 04.04.13 04.04.15 04.04.15							
Note QT:Qualification Test AT:Assurance Test X:Applicable Test														
אנכ								\\	PART				·	
CODE NO CO	HIROSE ELECTRIC CO., LTD. SPECIFICATION SHEET DF1E- * P-2.5DS(CODE NO.(OLD) DRAWING NO. PART NO.										(05)) · 1 /		
CI	LUJ					31951-0	า1	'		CI 541				1/4